

N-channel MOSFET

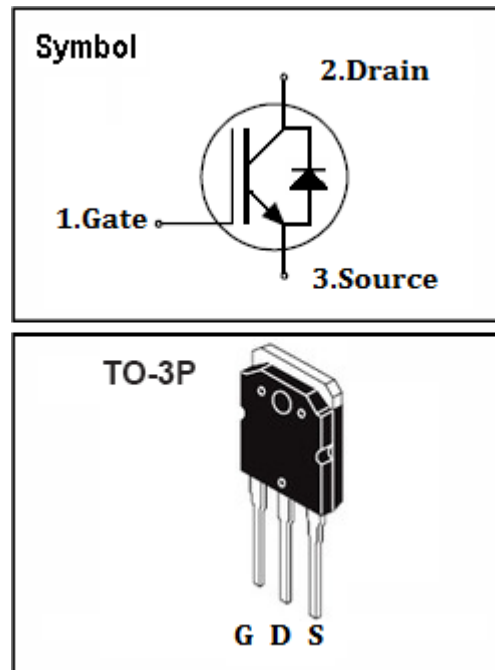
Features

- 500V,20A
- $R_{DS(on)}=0.21\Omega$ @ $V_{GS}=10V, I_D=10A$
- High speed switching
- High ruggedness
- 100% avalanche tested
- Improved dv/dt capability

General Description

KDF20N50 is well suited for high efficiency switched mode power supplies, active power factor correction based on half bridge topology.

Absolute Maximum Ratings



Symbol	Parameter	Value	Units
V_{DSS}	Drain-Source Voltage	500	V
V_{GS}	Gate-Source Voltage	± 30	V
I_D	Continuous Drain Current($T_C=25^\circ C$)	20	A
I_{DM}	Pulsed Drain Current(Note 1)	80	A
EAS	Single Pulsed Avalanche Energy(Note 2)	1100	mJ
dV/dt	Peak Diode Recovery dv/dt(Note 3)	4.5	V/ns
P_D	Maximum Power Dissipation ($T_C=25^\circ C$)	280	W
	Maximum Power Dissipation ($T_C=100^\circ C$)	112	W
T_J	Operating Junction Temperature Range	-55 to +150	$^\circ C$
T_{STG}	Storage Temperature Range	-55 to +150	$^\circ C$

Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature
2. Starting $T_J=25^\circ C, L=5mH, R_G=50\Omega, I_D=20A, V_{GS}=10V$
3. $I_{SD} \leq 20A, di/dt \leq 200A/us, V_{DD} \leq BV_{DSS}$. Starting $T_J=25^\circ C$

Thermal data

Symbol	Parameter	Max.	Units
$R_{th J-C}$	Thermal Resistance, Junction to case	0.44	$^\circ C / W$
$R_{th J-A}$	Thermal Resistance, Junction to ambient	40	$^\circ C / W$

Electrical Characteristics ($T_C=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=250\mu A$	500	-	-	V
I_{DSSS}	Drain-Source Leakage Current	$V_{DS}=500V, V_{GS}=0V$	-	-	1	μA
I_{GSS}	Gate Leakage Current, Forward	$V_{GS}=25V, V_{DS}=0V$	-	-	100	nA
	Gate Leakage Current, Reverse	$V_{GS}=-25V, V_{DS}=0V$	-	-	-100	nA
$V_{GS(th)}$	Gate Threshold Voltage	$V_{GS}=V_{DS}, I_D=250\mu A$	2	-	4.5	V
$R_{DS(on)}$	Collector-Emitter Saturation Voltage	$V_{GS}=10V, I_D=10A$	-	0.21	-	Ω
Q_g	Total Gate Charge	$V_{DD}=400V$ $V_{GS}=10V$ $I_D=20A$	-	70	-	nC
Q_{gs}	Gate-Source Charge		-	20	-	nC
Q_{gd}	Gate-Drain Charge		-	35	-	nC
$t_{d(on)}$	Turn-on Delay Time	$V_{DS}=250V$ $V_{GS}=10V$ $I_D=20A$ $R_G=25\Omega$	-	100	-	ns
t_r	Turn-on Rise Time		-	400	-	ns
$t_{d(off)}$	Turn-off Delay Time		-	100	-	ns
t_f	Turn-off Fall Time		-	100	-	ns
C_{iss}	Input Capacitance	$V_{DS}=25V$ $V_{GS}=0V$ $f=100kHz$	-	2750	-	pF
C_{oss}	Output Capacitance		-	420	-	pF
C_{rSS}	Reverse Transfer Capacitance		-	40	-	pF

Source-Drain Ratings and Characteristics ($T_C=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
V_{SD}	Forward On Voltage	$V_{GS}=0V, I_S=20A$	-	-	1.5	V
I_S	Continuous Diode Forward Current		-	-	20	A
I_{SM}	Maximum Pulsed Drain-Source Diode Forward Current				80	A
t_{rr}	Reverse Recovery Time	$V_{GS}=0V, I_S=20A$ $dI_F/dt=100A/\mu s$	-	510		ns
Q_{rr}	Reverse Recovery Charge		-	7.3		μC

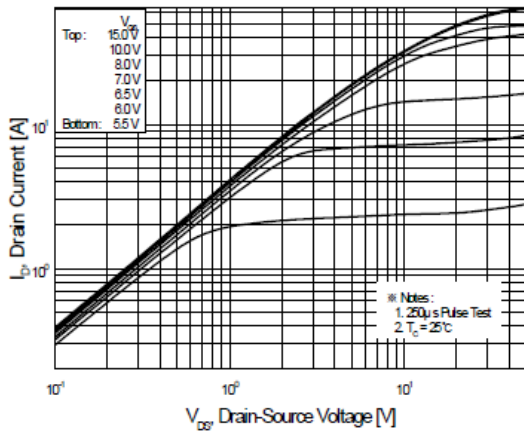


Figure 1. On-Region Characteristics

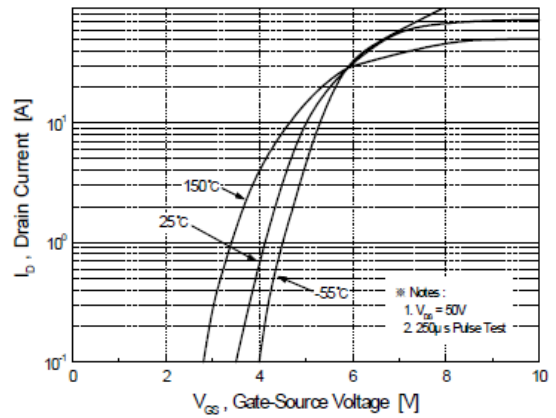


Figure 2. Transfer Characteristics

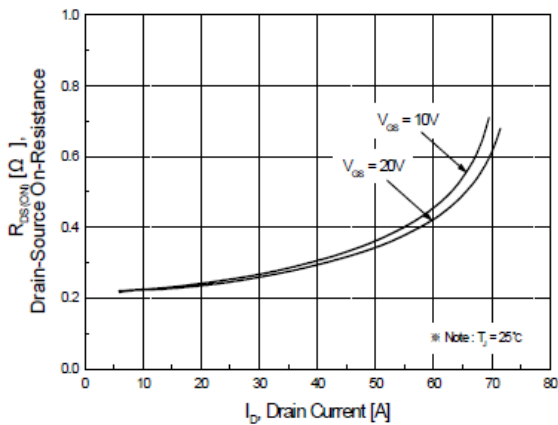


Figure 3. On-Resistance Variation vs

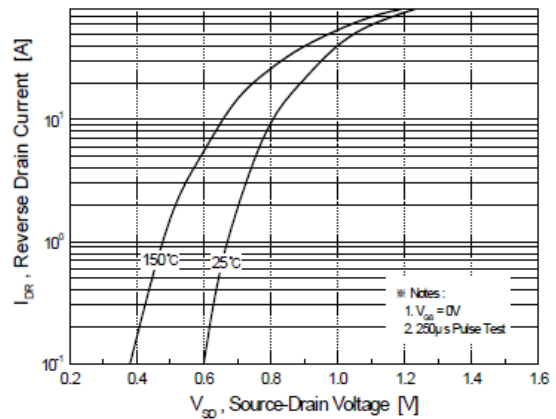


Figure 4. Body Diode Forward Voltage

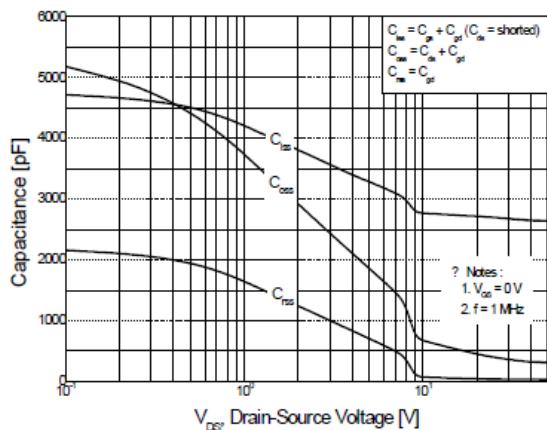


Figure 5. Capacitance Characteristics

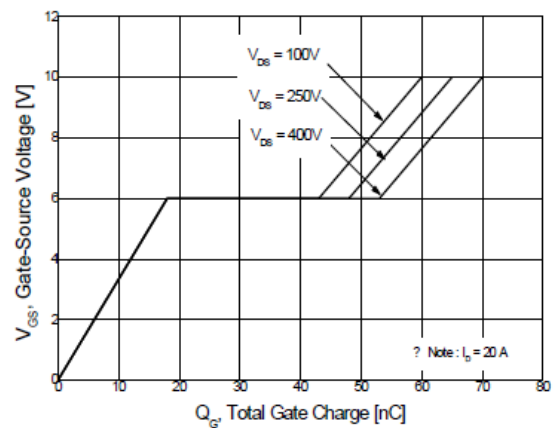


Figure 6. Gate Charge Characteristics

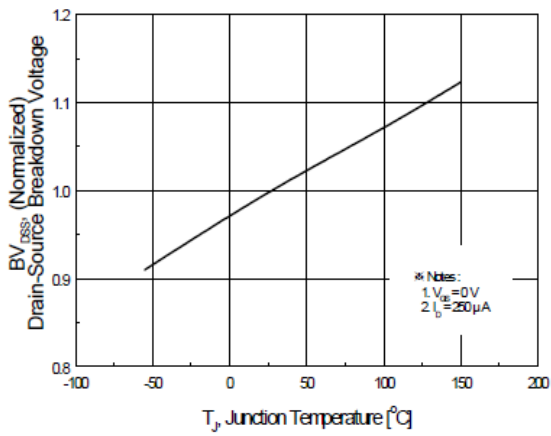


Figure 7. Breakdown Voltage Variation

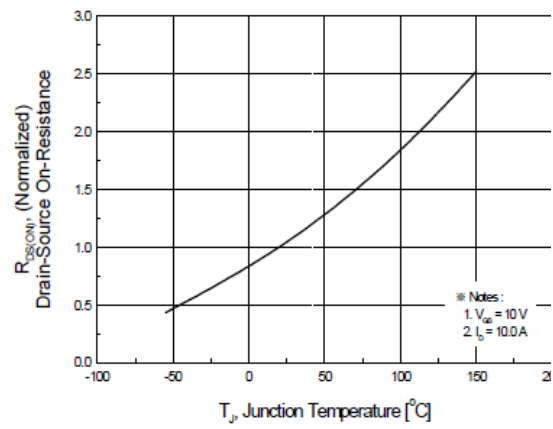


Figure 8. On-Resistance Variation

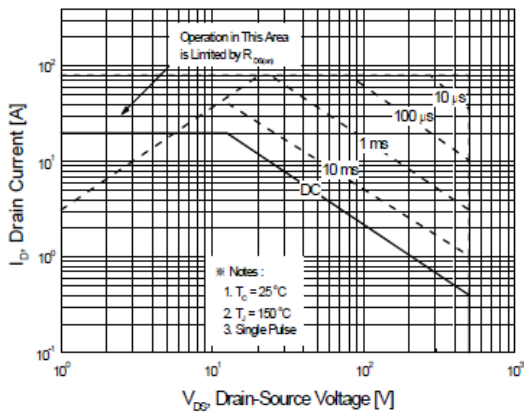


Figure 9. Maximum Safe Operating Area

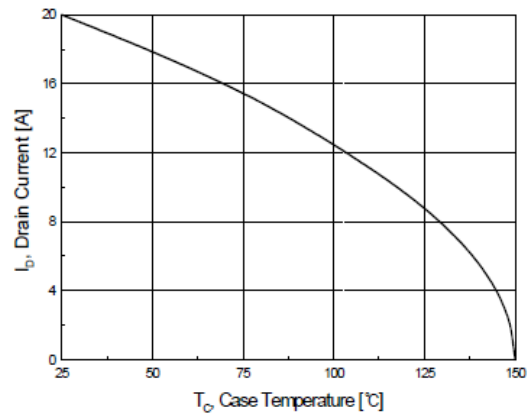


Figure 10. Maximum Drain Current vs Case Temperature

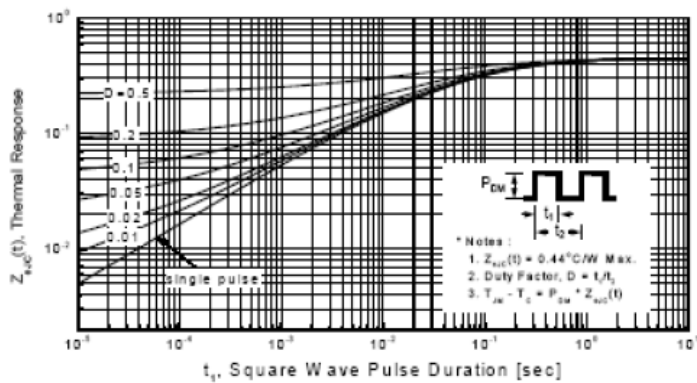


Figure 11. Transient Thermal Response Curve

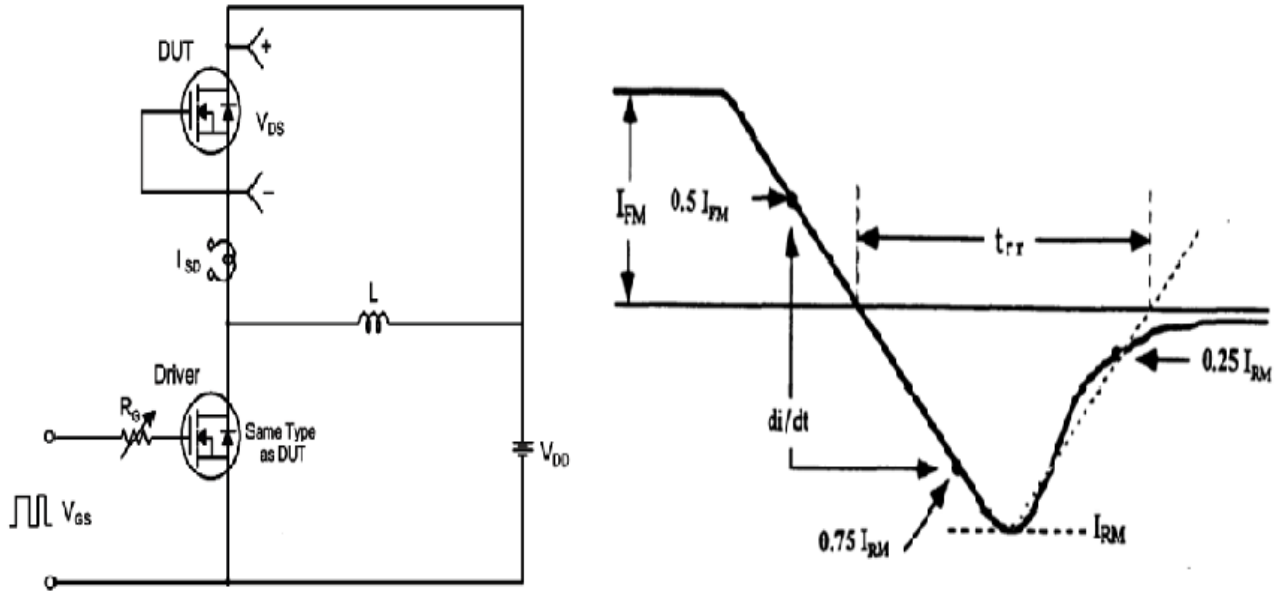


Fig12. Diode reverse recovery test circuit waveform

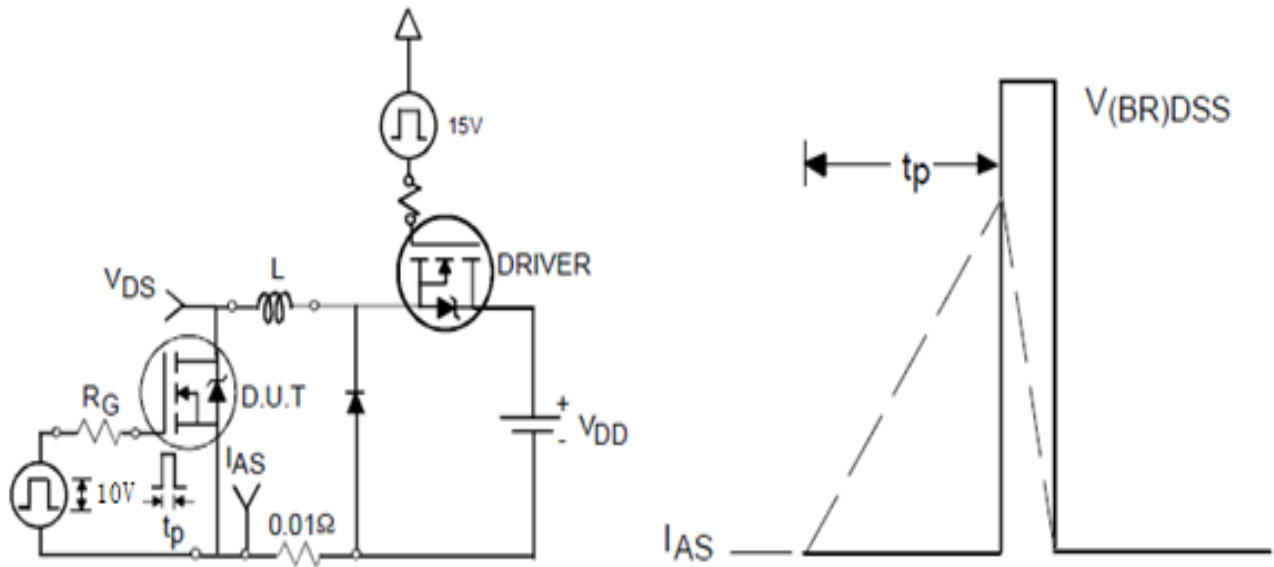


Fig13. Unclamped inductive test circuit waveform

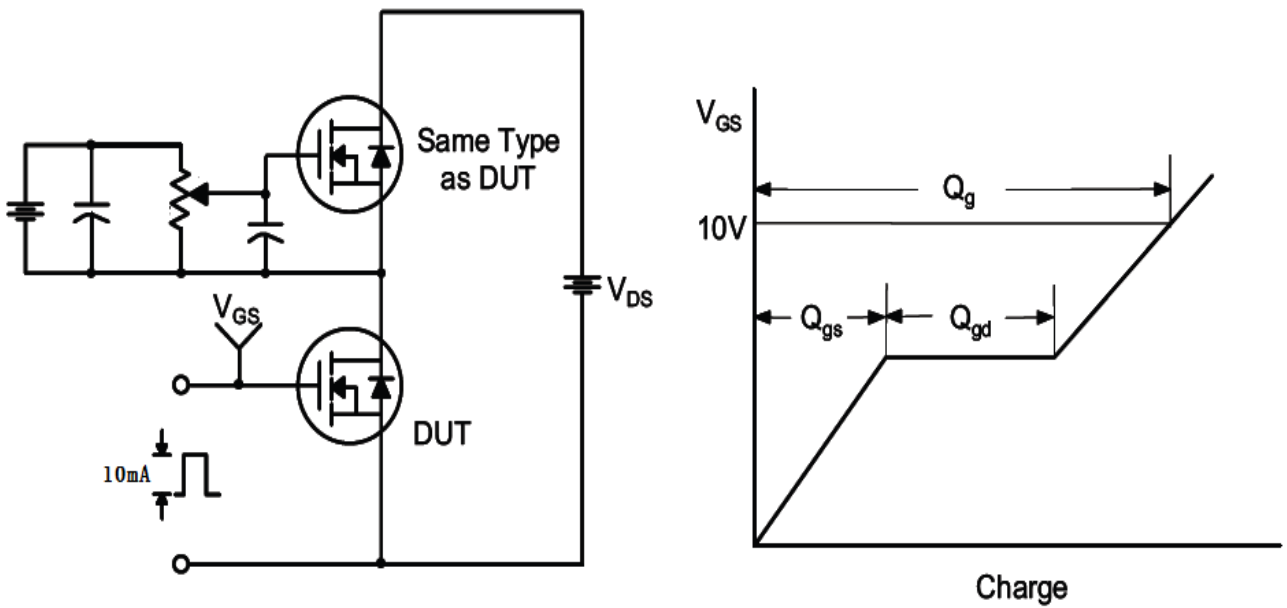


Fig14. Gate charge test circuit waveform

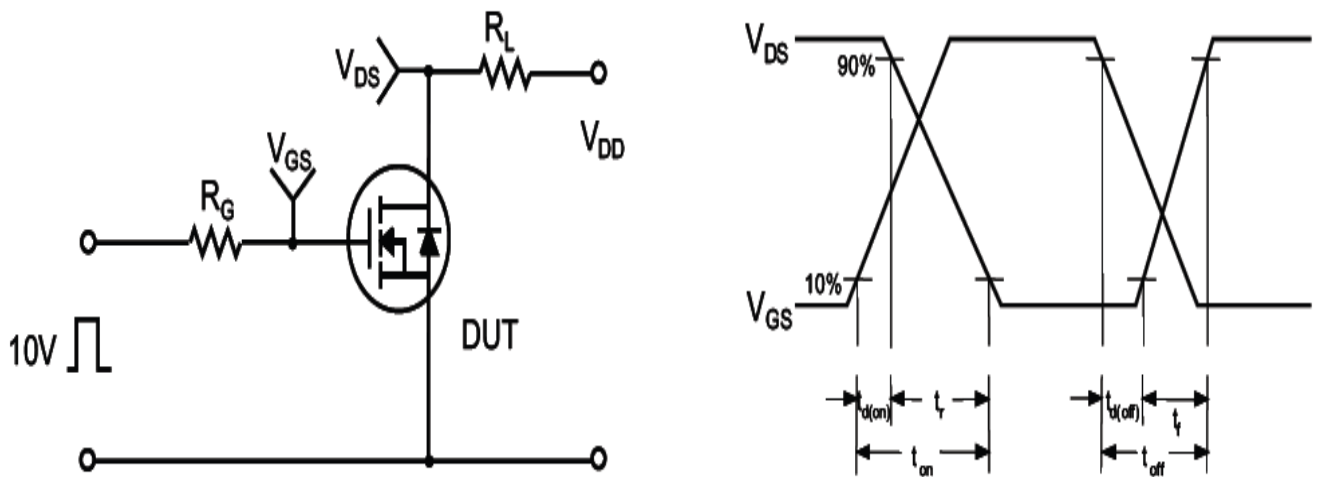
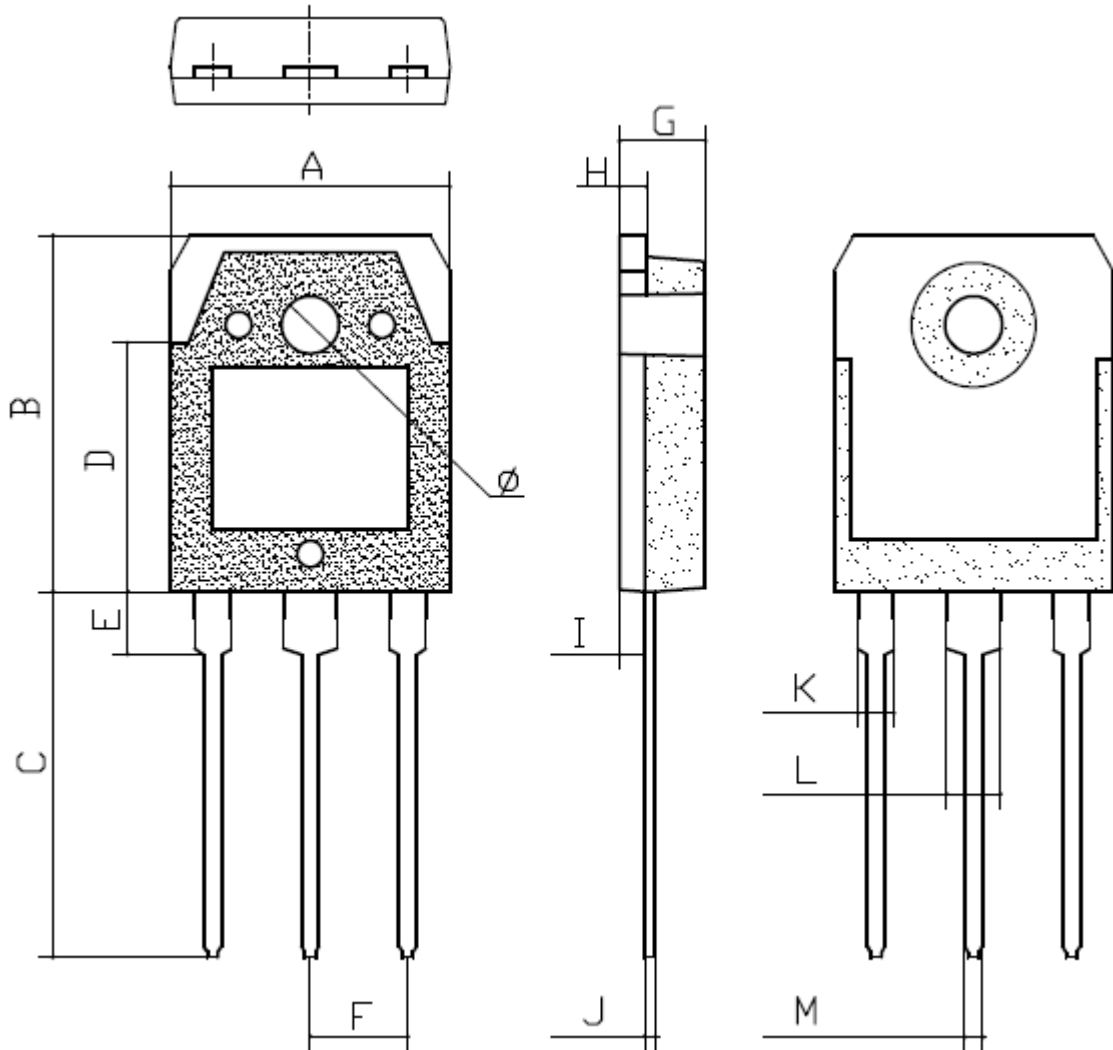


Fig15. Switching time waveform



TO3P PACKAGE OUTLINE



Ø	3.160	3.240	0.124	0.128
M	0.980	1.020	0.039	0.040
L	2.980	3.020	0.117	0.119
K	1.980	2.020	0.078	0.080
J	0.500	0.700	0.500	0.700
I	1.330	1.430	0.053	0.056
H	1.400	1.600	0.055	0.063
G	4.700	4.900	0.185	0.193
F	5.450 TYP		0.215 TYP	
E	3.480	3.520	0.137	0.139
D	13.800	14.000	0.543	0.551
C	20.300	20.500	0.799	0.807
B	19.800	20.000	0.780	0.787
A	15.500	15.700	0.610	0.618
Symbol	Min	Max	Min	Max
	Dimensions In Millimeters		Dimensions In Inches	

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